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(12) **United States Design Patent** (10) **Patent No.:** **US D971,907 S**  
**Cho et al.** (45) **Date of Patent:** **\*\* Dec. 6, 2022**

(54) **CASE FOR ELECTRONIC DEVICE**

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(\*\*) Term: **15 Years**

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(30) **Foreign Application Priority Data**

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(51) **LOC (13) Cl.** ..... **14-03**

(52) **U.S. Cl.**  
USPC ..... **D14/250**

(58) **Field of Classification Search**

USPC ..... D3/201, 218; D14/217, 248, 250-253,  
D14/432, 434, 440, 441, 447  
CPC ..... H04B 1/3888; H04M 1/0283;  
H04M 1/0202; A45F 2005/028; A45F  
2200/0525

See application file for complete search history.

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(57) **CLAIM**

The ornamental design for a case for electronic device, as shown and described.

**DESCRIPTION**

FIG. 1 is a front perspective view of a case for electronic device showing our new design;  
FIG. 2 is a front elevation view thereof;  
FIG. 3 is a rear elevation view thereof;  
FIG. 4 is a left side elevation view thereof;  
FIG. 5 is a right side elevation view thereof;  
FIG. 6 is a top plan view thereof;  
FIG. 7 is a bottom plan view thereof; and,  
FIG. 8 is a rear perspective view thereof.  
The broken lines in the figures illustrate portions of the case for electronic device that form no part of the claimed design.

**1 Claim, 8 Drawing Sheets**

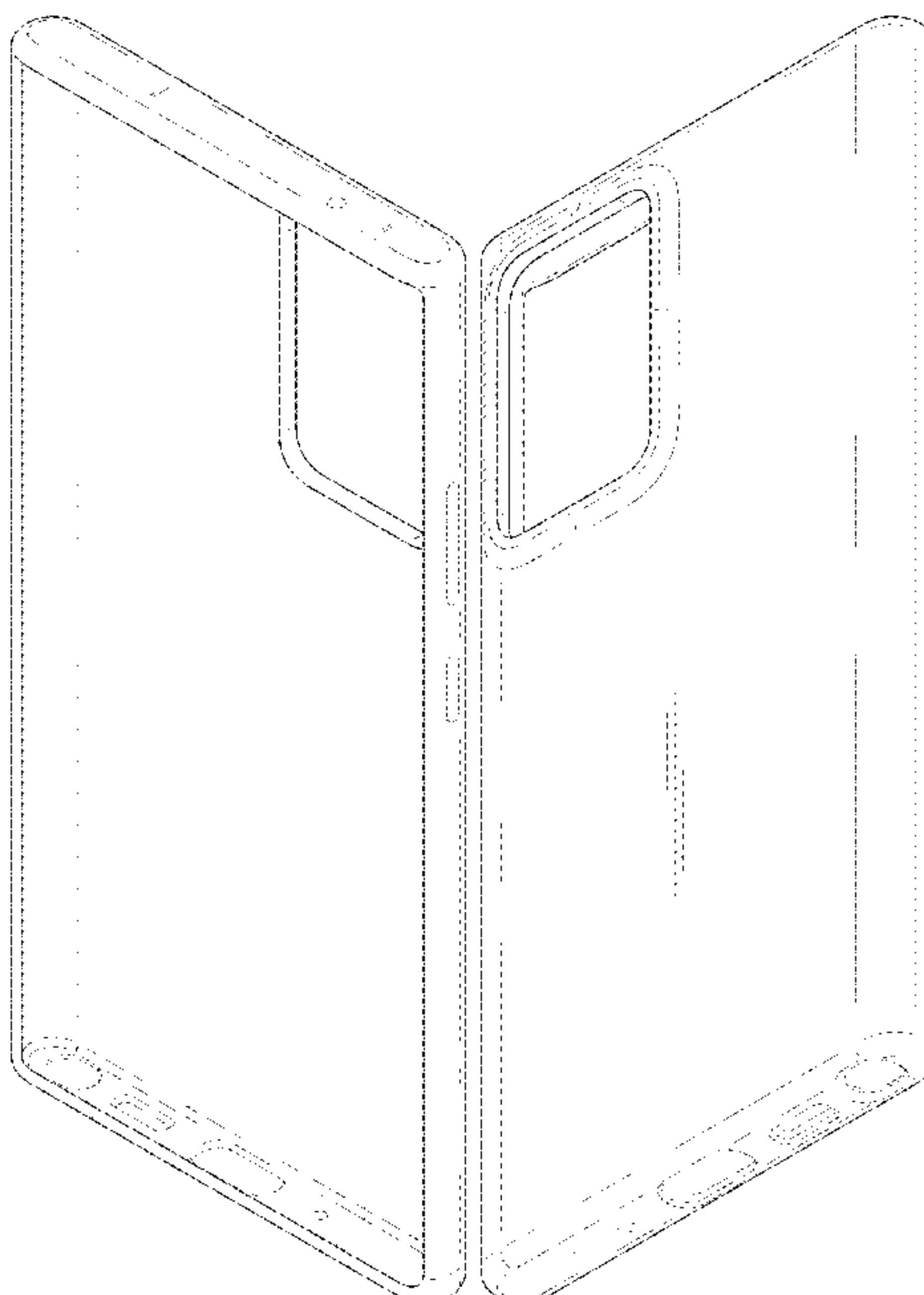


FIG. 1

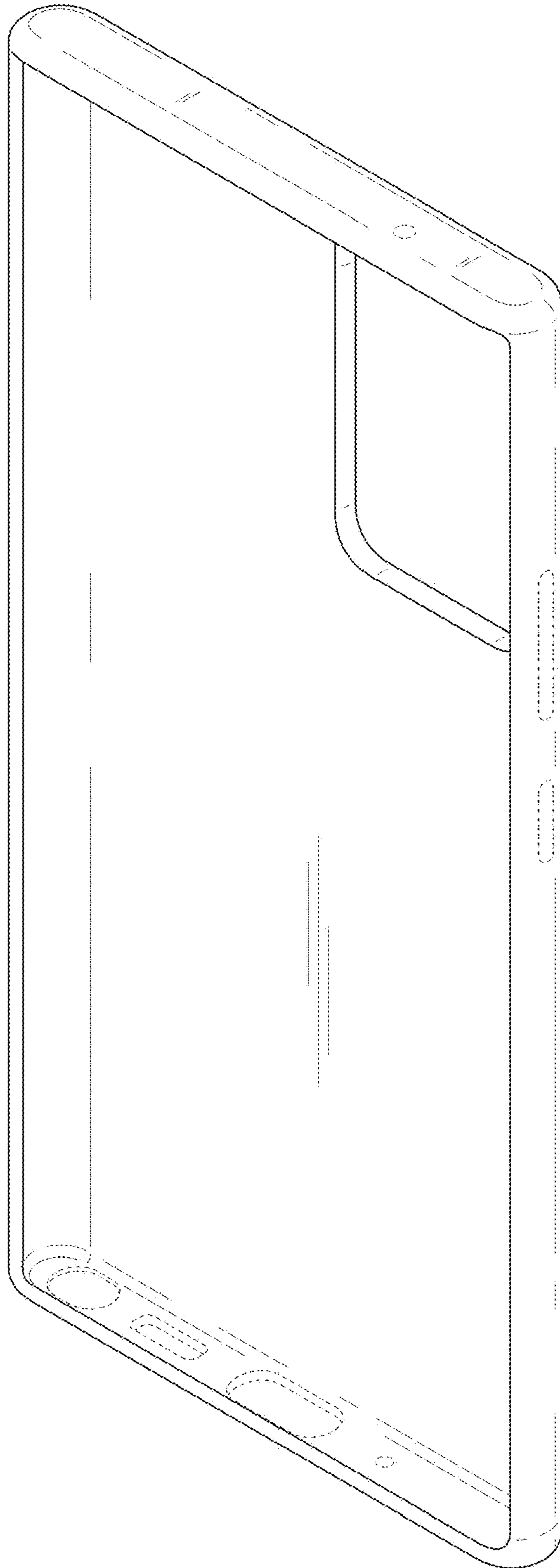


FIG. 2

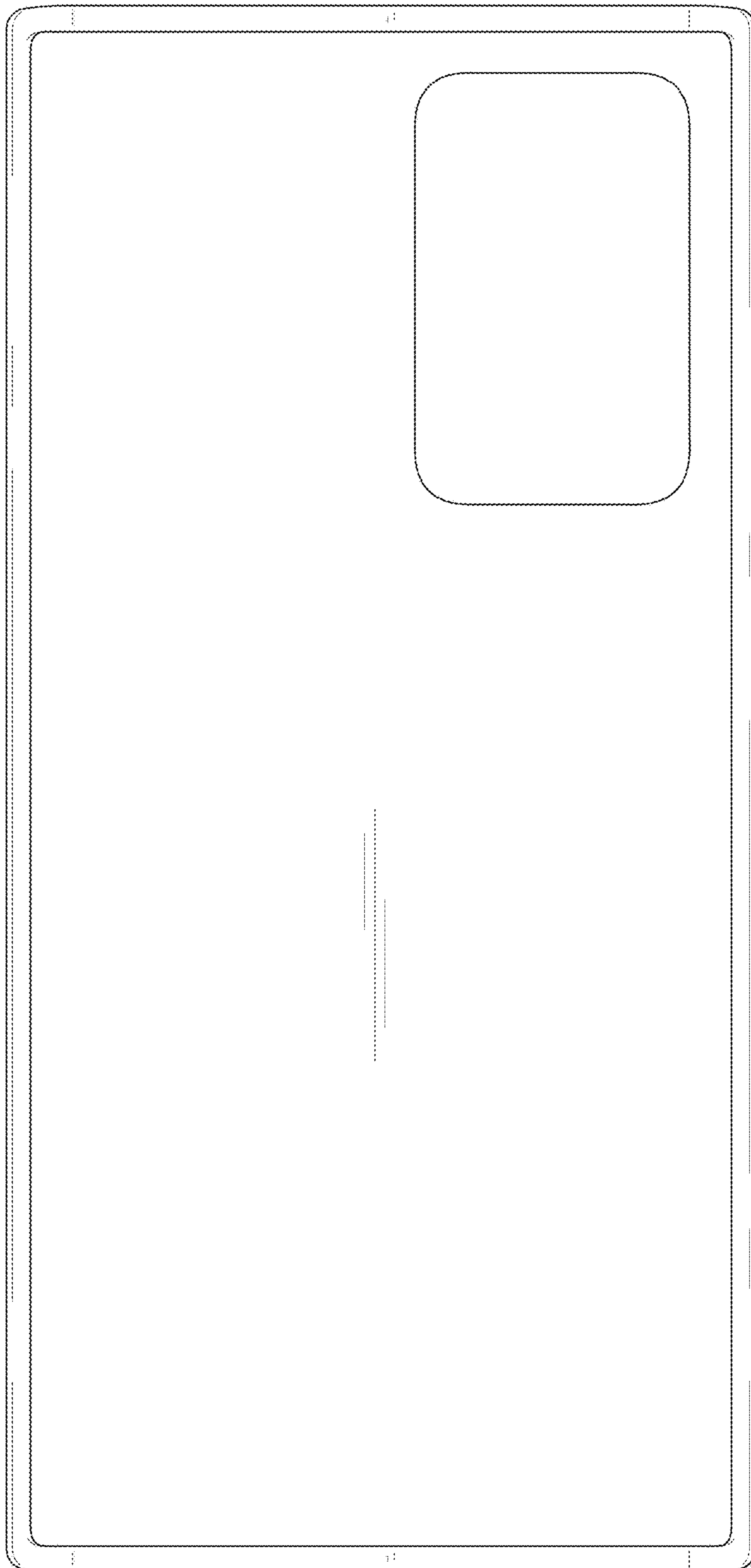


FIG. 3

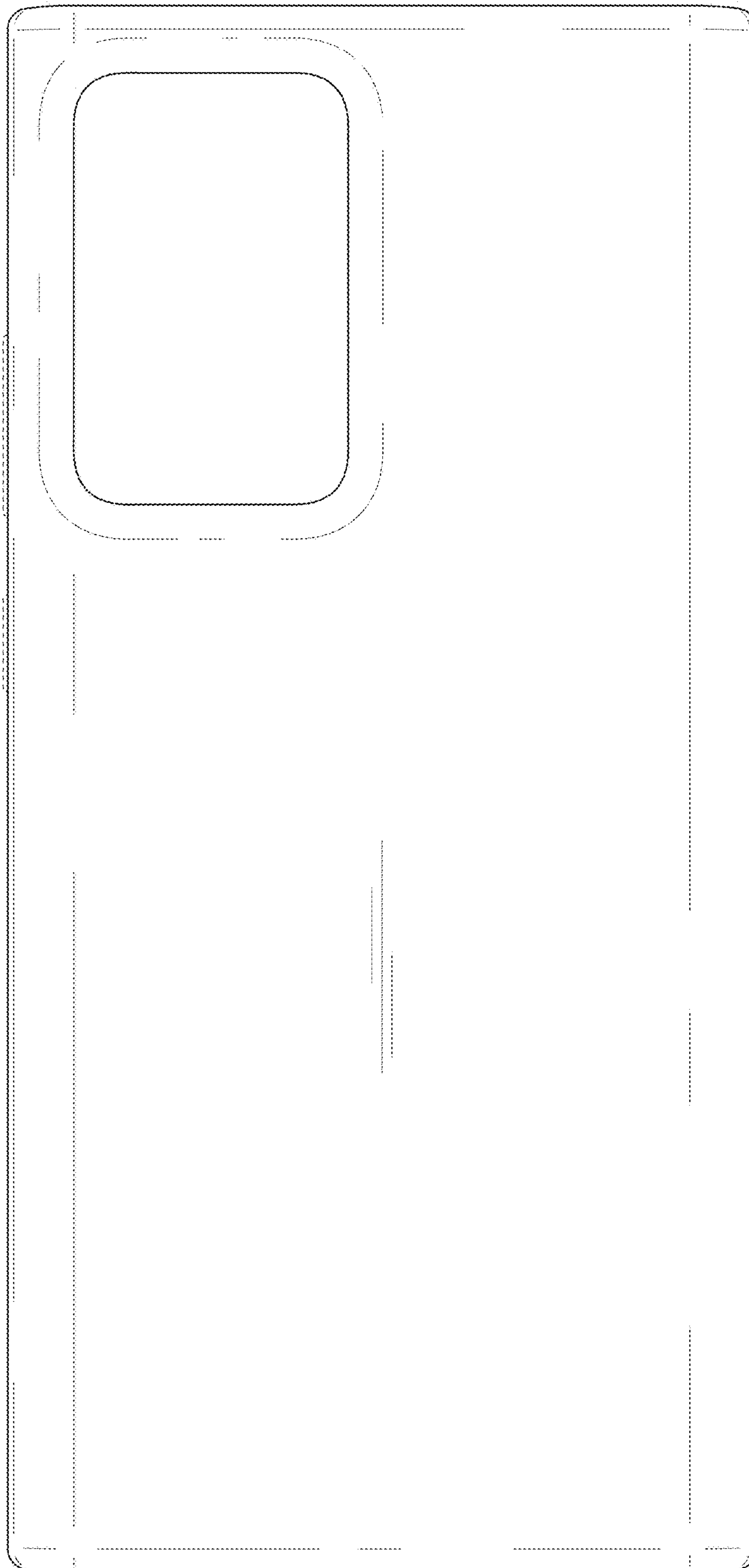


FIG. 4

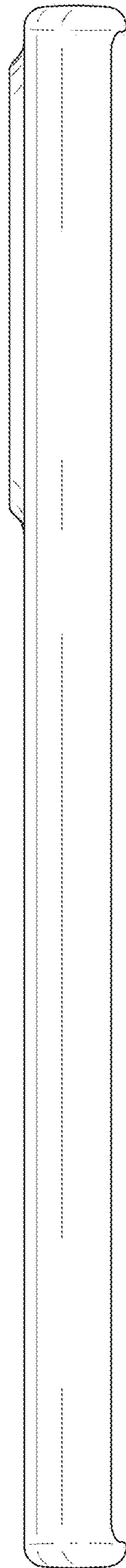


FIG. 5

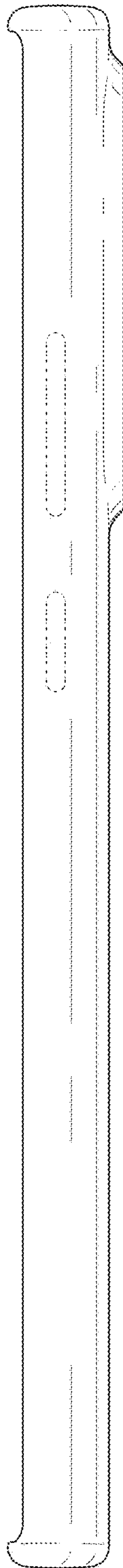


FIG. 6

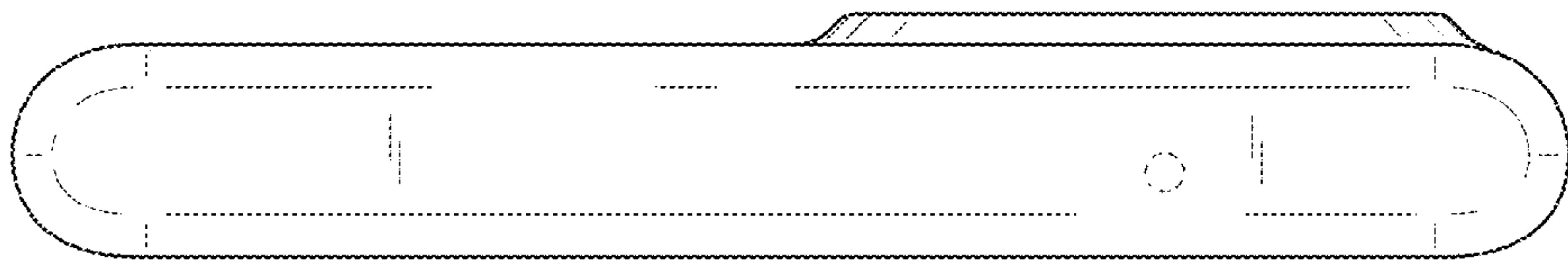




FIG. 7

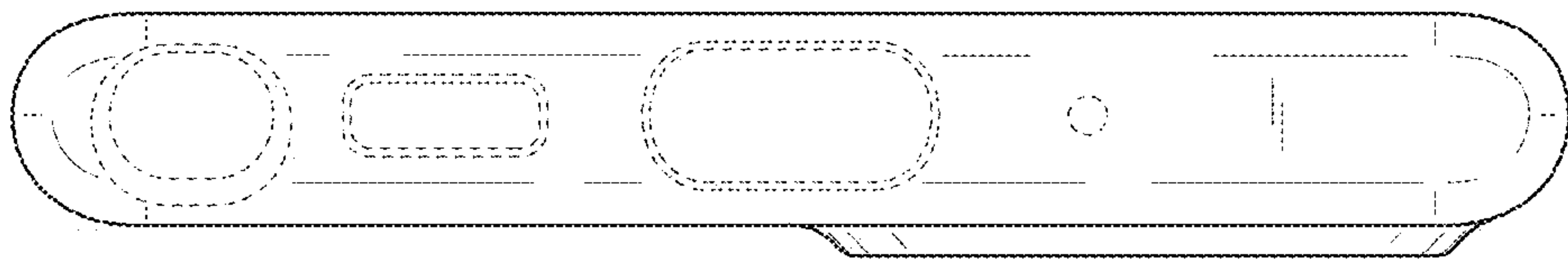




FIG. 8

